

High Density Interconnect (HDI) PCBs Market 2017 Global Share, Trend, Segmentation and Forecast to 2022

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[Global High Density Interconnect \(HDI\) PCBs Market](#)

Description

This report studies High Density Interconnect (HDI) PCBs in Global market, especially in North America, China, Europe, Southeast Asia, Japan and India, with production, revenue, consumption, import and export in these regions, from 2012 to 2016, and forecast to 2022.

This report focuses on top manufacturers in global market, with production, price, revenue and market share for each manufacturer, covering

IBIDEN Group
NCAB Group
Bittele Electronics
TTM Technologies
Unimicron
AT&S
SEMCO
Young Poong Group
ZDT
Unitech Printed Circuit Board
LG Innotek
Tripod Technology
Daeduck
HannStar Board
Nan Ya PCB
CMK Corporation



Kingboard
Ellington
Wuzhu Technology
Kinwong
Aoshikang
Sierra Circuits
Epec
Würth Elektronik
NOD Electronics

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By types, the market can be split into
4-6 Layers HDI PCBs
8-10 Layer HDI PCBs
10+ Layer HDI PCBs

By Application, the market can be split into
Automotive (Engine Control Units, GPS, Dashboard Electronics)
Computers (Laptops, Tablets, Wearable Electronics, Internet of Things - IoT)
Communication (Mobile phones, Modules, Routers, Switches)
Digital (Cameras, Audio, Video)
Others

By Regions, this report covers (we can add the regions/countries as you want)
North America
China
Europe
Southeast Asia
Japan
India

Complete Report Details @ <https://www.wiseguyreports.com/reports/1554456-global-high-density-interconnect-hdi-pcbs-market-professional-survey-report-2017>

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